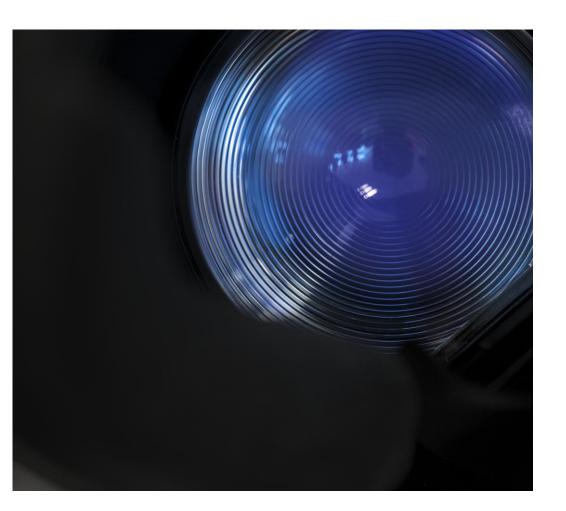
TE&IV in O-RAN SC Opensource Contribution -Proposal

Information, plan & call for support

Content

- Open-Source TE&IV, reference implementation
 O-RAN Source Community, SMO project
- A bit about TE&IV, topology, definition, context, goals
- Deep dive areas



- Open-Source TE&IV, reference implementation
 - O-RAN Source Community, SMO project
- A bit about TE&IV, topology, definition, context, goals
- Deep dive areas

- Ericsson is proposing to contribute a new component to the O-RAN SC SMO project to develop a reference implementation for the emerging TE&IV
- The initial focus is on supporting rApps (R1 interfaces & models)
- The goals are to:
 - Accelerate R1 topology API specification
 - Collaborate with the activities in WG10 w.r.t. TE&IV IM and API definitions (Stage 2/3)
 - Garner early cross community support for some basic TE&IV concepts
 - Enhance the overall SMO and rApp (Non-RT RIC) DX & UX
- Community participation (beyond Ericsson) will be essential to the success of this activity

- Open-Source TE&IV, reference implementation
 - O-RAN Source Community, SMO project
- A bit about TE&IV, topology, definition, context, goals
- Deep dive areas

- What is topology?
- How does RAN OM CM and TE&IV overlap?
- What do we want from a TE&IV?

What is Topology & Inventory?

Topology is important things and the relationships between them.

'Important' is subjective

- Broad definitions give
 - complex structures
 - too much data
 - slow queries
 - "Source Envy"

Opinionated perspective

- Initially rApp focused
 - rApp use case needs
 - Ease rApp development
- Portability & multi-vendor
- Facilitate rApp ecosystem
 - Move fast and break nothing

Principles

- Lean and lightweight
 - Just enough topology
- Grow with rApps use cases
- Aligned with and proving the standard
- Complement CM

Topology & Inventory complement Configuration / Source

Configuration / Source e.g.: NCMP

- Device centric
 - Important things may be buried
- Device specific
 - − Single-vendor rApps → All details
 - − Multi-vendor rApps → Standard parts

Topology & Inventory

- Overview of important things
- Network wide perspective
- Multi-domain (telecom) perspective
- Vendor/device agnostic
- Other non-CM data sources

No hard and fast rule to define a distinct boundary between CM and Topology. There will always be an overlap.

APIs and Models



API provides generic access to any topology entity type.

- Separate LCM to model
- Less likely to change
- No cognitive load contribution when changing telecom domains
- APIs follow SemVer 2
- APIs are not impacted by Models updates

Models are domain specific and created in separate namespaces

- Namespaces have separate
 LCM
- Namespaces may be developed independently
- rApps (TE&IV consumers) depend on subset of namespaces, not all
- Models follow SemVer 2
- Models are not impacted by API updates

rApps declare which TE&IV namespaces they use

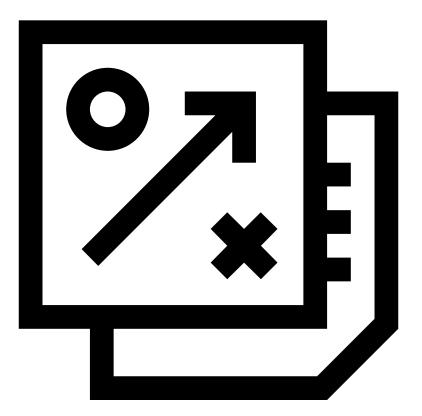
- Only relevant model changes
 will impact rApp
- Only .x version changes impact rApp
- Operators can easily determine which rApps will be impacts by TE&IV model updates
- rApps are only impacted by changes in namespaces they use

Balance



- TE&IV will not have everything that is needed by consumers. It is a complement for Configuration Management and other sources
- TE&IV uses CM and other sources as the 'database-of-record' for important things and their relations
- Custom queries, Classifiers, Collections and Decorators complement topology models
- TE&IV will evolve to support growing needs of rApps first. Other consumers will follow.

Expectations



- Development is needed to ensure a fully functional reference implementation in OSC
- Community participation (beyond Ericsson) will be useful to the success of this activity
- Avoid a proliferation of alternative implementations
- Inform, and accelerate the TE&IV Stage 3 specifications

Deep dive areas

